

# RJK03C2DPB

## Silicon N Channel Power MOS FET with Schottky Barrier Diode Power Switching

REJ03G1831-0200

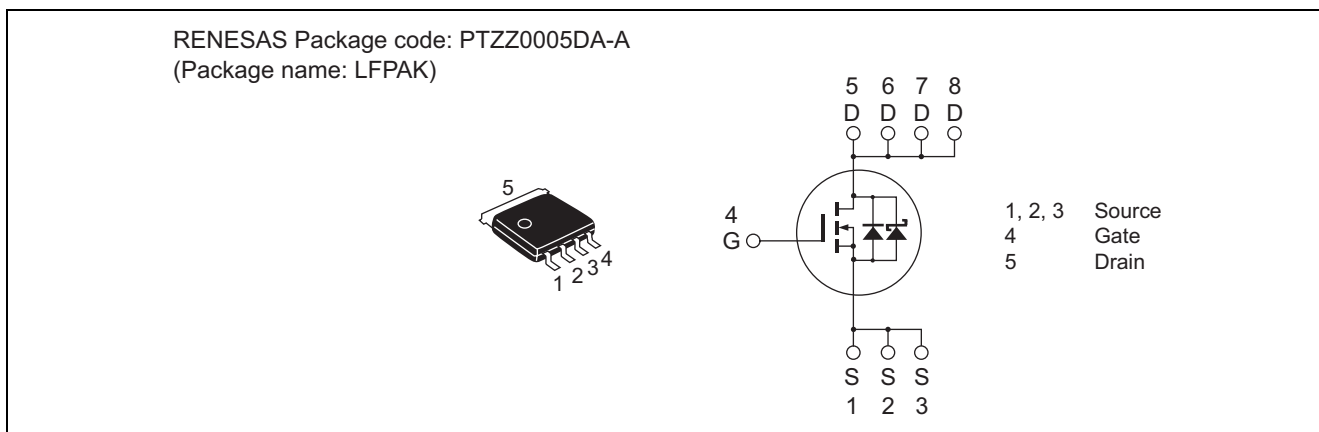
Rev.2.00

Sep 29, 2009

### Features

- High speed switching
- Capable of 4.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance  
 $R_{DS(on)} = 1.9 \text{ m}\Omega$  typ. (at  $V_{GS} = 10 \text{ V}$ )
- Pb-free
- Halogen-free

### Outline



### Absolute Maximum Ratings

( $T_a = 25^\circ\text{C}$ )

Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{DSS}$	30	V
Gate to source voltage	$V_{GSS}$	$\pm 20$	V
Drain current	$I_D$	55	A
Drain peak current	$I_{D(pulse)}$ <sup>Note 1</sup>	220	A
Body-drain diode reverse drain current	$I_{DR}$	55	A
Avalanche current	$I_{AP}$ <sup>Note 2</sup>	25	A
Avalanche energy	$E_{AR}$ <sup>Note 2</sup>	62.5	mJ
Channel dissipation	$P_{ch}$ <sup>Note 3</sup>	60	W
Channel to Case Thermal Resistance	$\theta_{ch-C}$	2.09	$^\circ\text{C/W}$
Channel temperature	$T_{ch}$	150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$

- Notes: 1.  $PW \leq 10 \mu\text{s}$ , duty cycle  $\leq 1\%$   
 2. Value at  $T_{ch} = 25^\circ\text{C}$ ,  $R_g \geq 50 \Omega$   
 3.  $T_c = 25^\circ\text{C}$

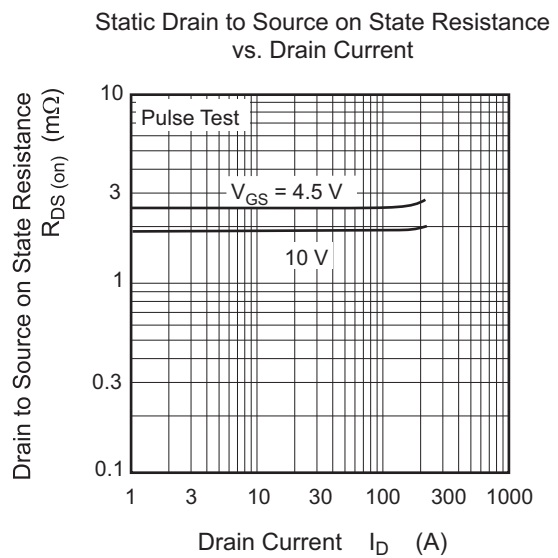
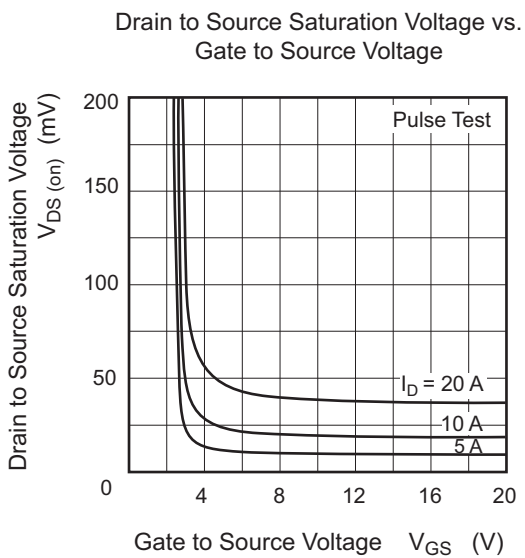
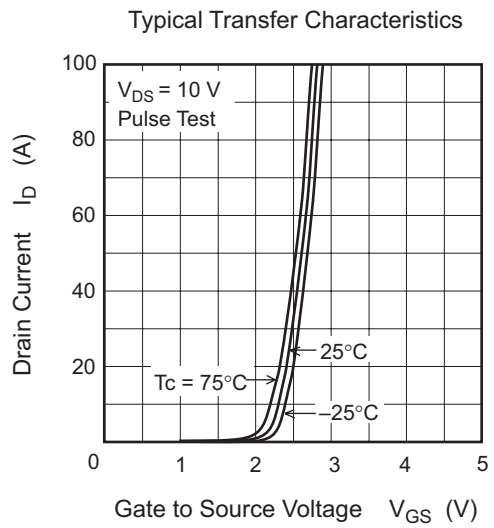
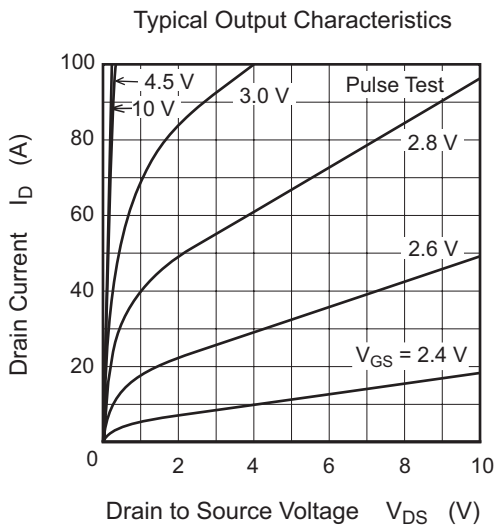
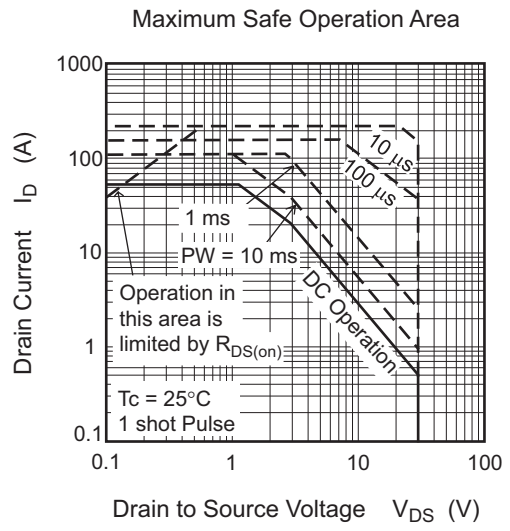
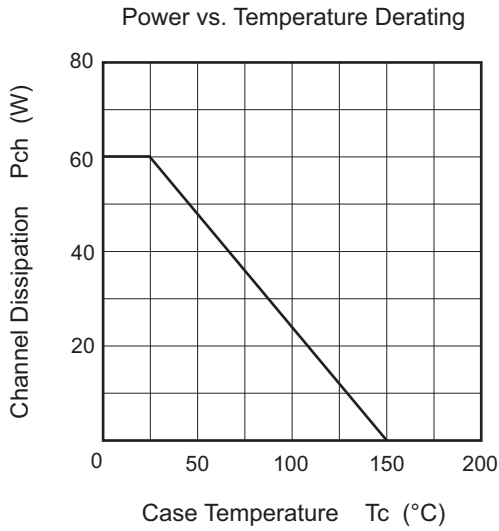
## Electrical Characteristics

(Ta = 25°C)

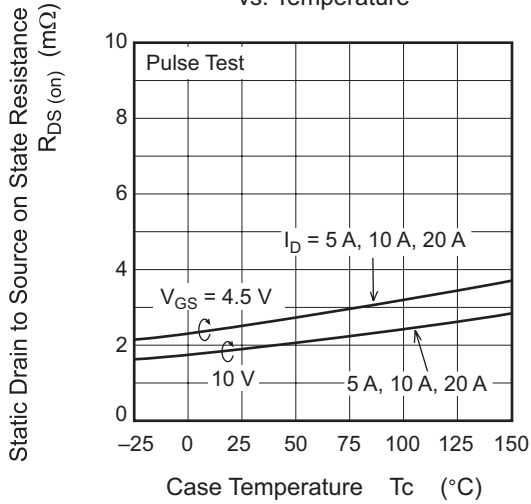
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	30	—	—	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source leak current	$I_{GSS}$	—	—	$\pm 0.5$	$\mu\text{A}$	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	$I_{DSS}$	—	—	1	m A	$V_{DS} = 30 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.2	—	2.5	V	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$
Static drain to source on state resistance	$R_{DS(on)}$	—	1.9	2.5	m $\Omega$	$I_D = 27.5 \text{ A}, V_{GS} = 10 \text{ V}$ <sup>Note4</sup>
	$R_{DS(on)}$	—	2.5	3.5	m $\Omega$	$I_D = 27.5 \text{ A}, V_{GS} = 4.5 \text{ V}$ <sup>Note4</sup>
Forward transfer admittance	$ y_{fs} $	—	115	—	S	$I_D = 27.5 \text{ A}, V_{DS} = 10 \text{ V}$ <sup>Note4</sup>
Input capacitance	$C_{iss}$	—	4900	—	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$ $f = 1 \text{ MHz}$
Output capacitance	$C_{oss}$	—	1050	—	pF	
Reverse transfer capacitance	$C_{rss}$	—	420	—	pF	
Gate Resistance	$R_g$	—	0.5	—	$\Omega$	
Total gate charge	$Q_g$	—	33	—	nC	$V_{DD} = 10 \text{ V}, V_{GS} = 4.5 \text{ V},$ $I_D = 55 \text{ A}$
Gate to source charge	$Q_{gs}$	—	13	—	nC	
Gate to drain charge	$Q_{gd}$	—	9	—	nC	
Turn-on delay time	$t_{d(on)}$	—	16	—	ns	$V_{GS} = 10 \text{ V}, I_D = 27.5 \text{ A},$ $V_{DD} \cong 10 \text{ V}, R_L = 0.36 \Omega,$ $R_g = 4.7 \Omega$
Rise time	$t_r$	—	17	—	ns	
Turn-off delay time	$t_{d(off)}$	—	64	—	ns	
Fall time	$t_f$	—	13	—	ns	
Body-drain diode forward voltage	$V_{DF}$	—	0.39	—	V	$I_F = 2 \text{ A}, V_{GS} = 0$ <sup>Note4</sup>
Body-drain diode reverse recovery time	$t_{rr}$	—	34	—	ns	$I_F = 55 \text{ A}, V_{GS} = 0$ $di_F/dt = 100 \text{ A}/\mu\text{s}$

Notes: 4. Pulse test

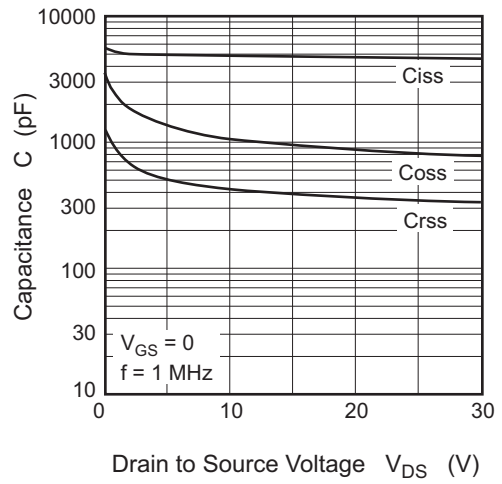
Main Characteristics



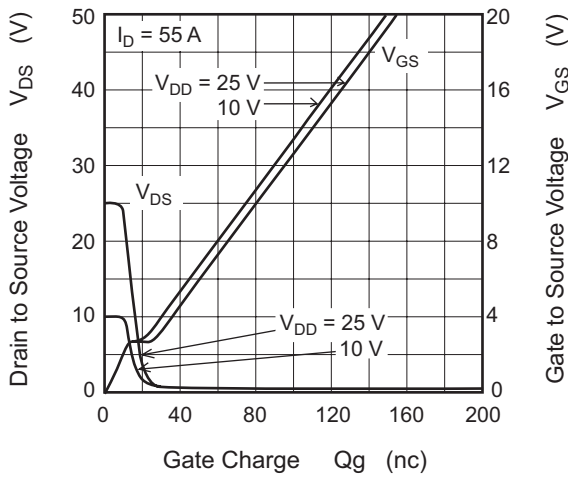
Static Drain to Source on State Resistance vs. Temperature



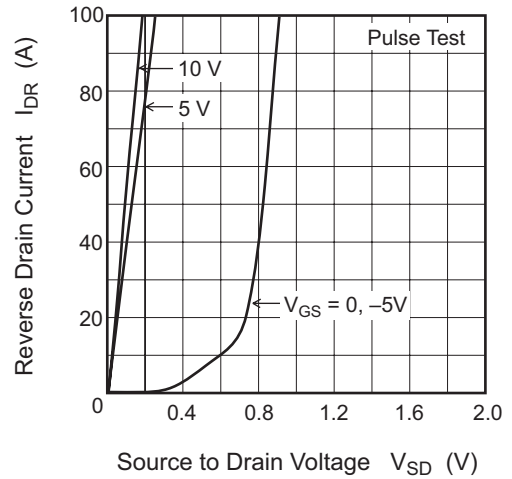
Typical Capacitance vs. Drain to Source Voltage



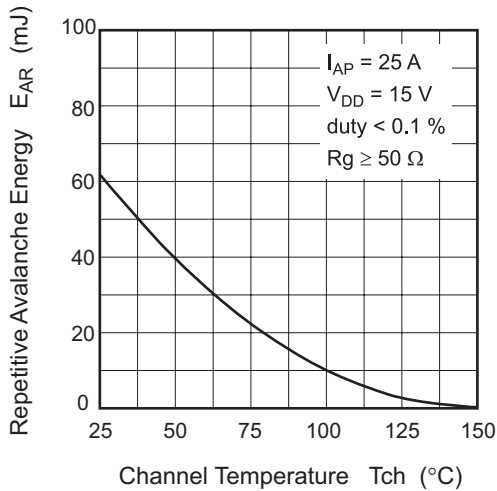
Dynamic Input Characteristics



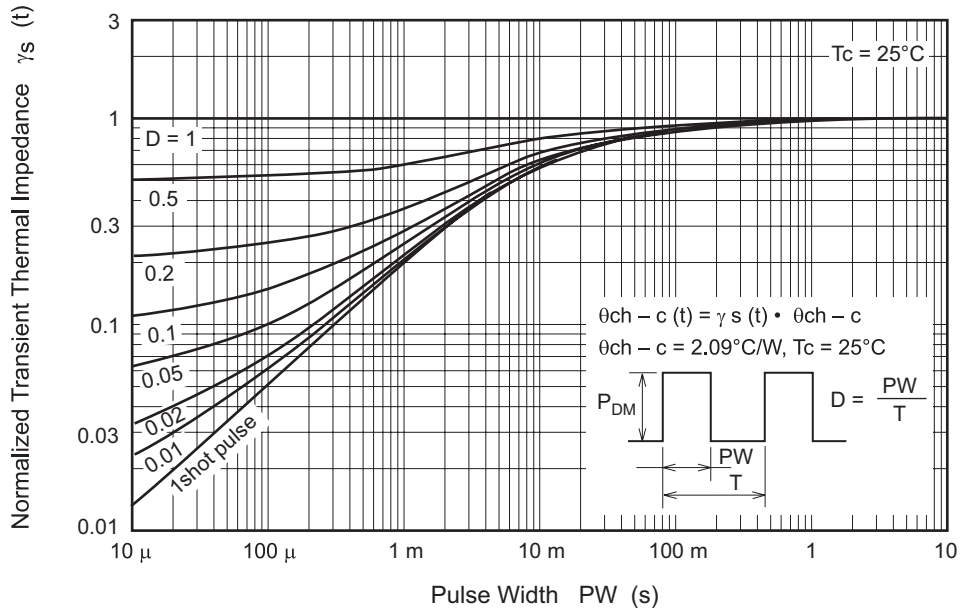
Reverse Drain Current vs. Source to Drain Voltage



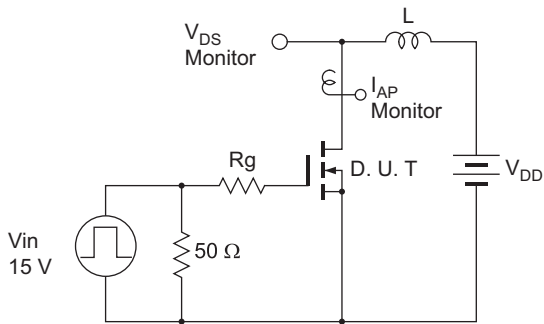
Maximum Avalanche Energy vs. Channel Temperature Derating



Normalized Transient Thermal Impedance vs. Pulse Width

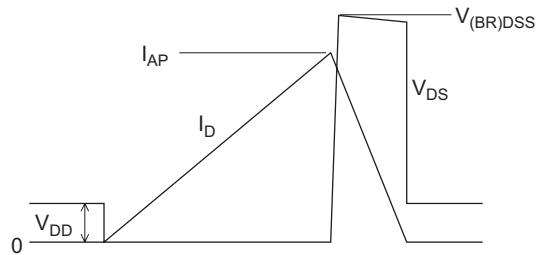


Avalanche Test Circuit

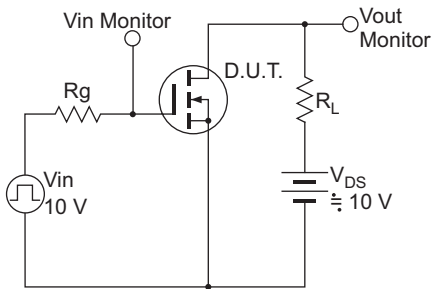


Avalanche Waveform

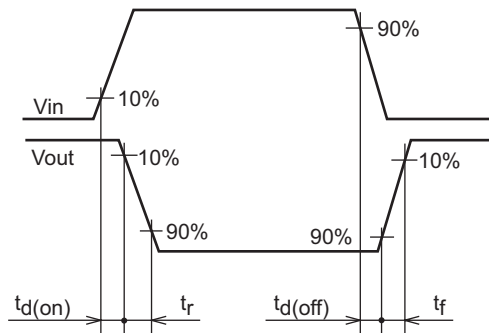
$$E_{AR} = \frac{1}{2} L \cdot I_{AP}^2 \cdot \frac{V_{DSS}}{V_{DSS} - V_{DD}}$$



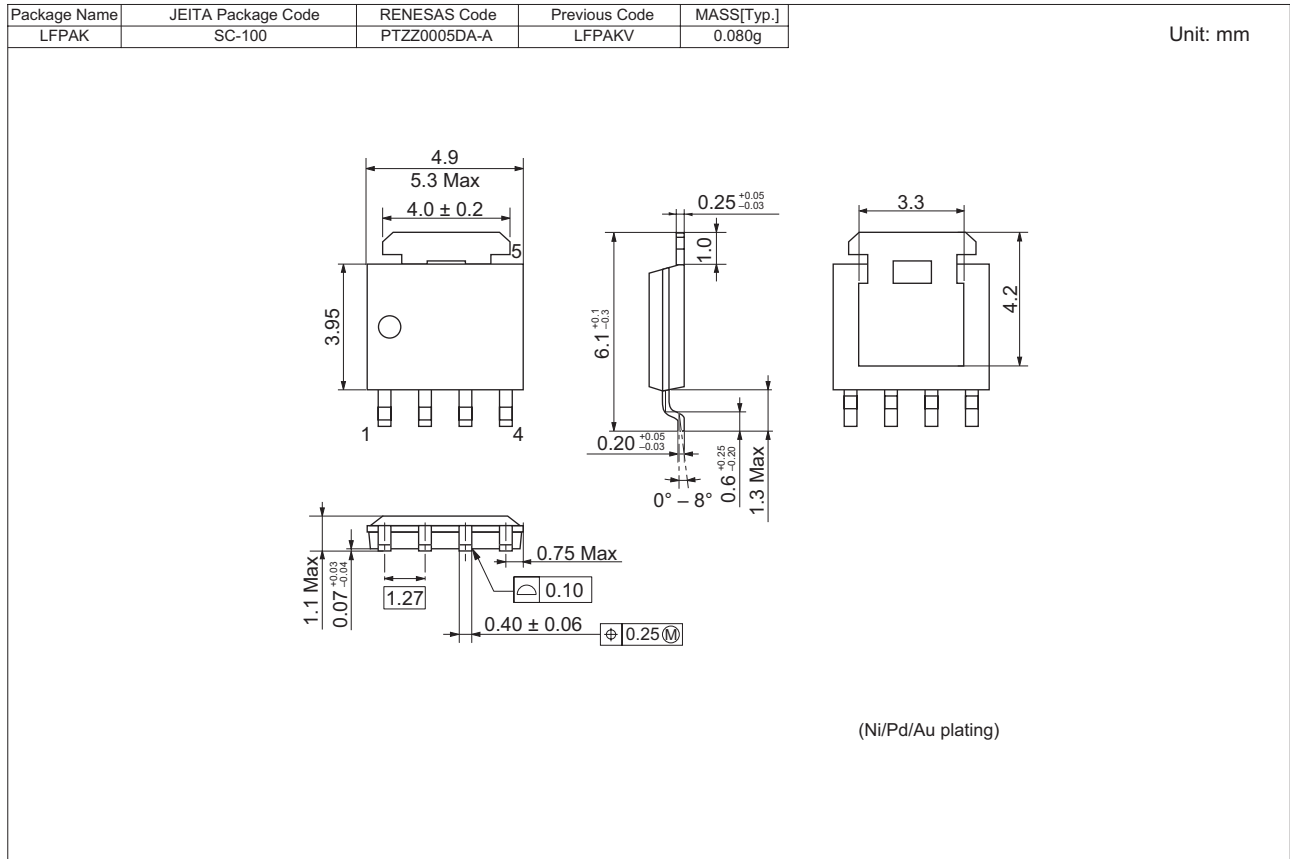
Switching Time Test Circuit



Switching Time Waveform



### Package Dimensions



### Ordering Information

Part No.	Quantity	Shipping Container
RJK03C2DPB-00-J5	2500 pcs	Taping

Notes:

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